



#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Product Summary**

| Device     | BV <sub>DSS</sub> | R <sub>DS(ON)</sub>             | I <sub>D</sub><br>T <sub>A</sub> = +25°C |
|------------|-------------------|---------------------------------|--|
| N-Channel  | 20V               | $42m\Omega$ @ $V_{GS}$ = $4.5V$ | 4.0A                                     |
| N-Channel  |                   | 60mΩ @ V <sub>GS</sub> = 2.5V   | 3.5A                                     |
| P-Channel  | 201/              | 70mΩ @ V <sub>GS</sub> = -4.5V  | -3.3A                                    |
| P-Griannei | -20V              | 100mΩ @ V <sub>GS</sub> = -2.5V | -2.8A                                    |

#### **Features and Benefits**

- Low On-Resistance
- Low Input Capacitance
- · Fast Switching Speed
- Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

#### **Description**

This new generation MOSFET is designed to minimize the on-state resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

### **Applications**

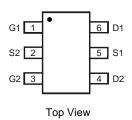
- Backlighting
- DC-DC Converters
- Power Management Functions

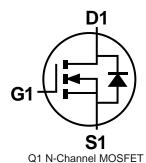
#### **Mechanical Data**

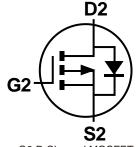
- Case: TSOT26
- Case Material: Molded Plastic, "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
   Solderable per MIL-STD-202, Method 208 (§3)
- Weight: 0.013 grams (Approximate)











Q2 P-Channel MOSFET

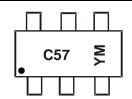
#### Ordering Information (Note 4)

| Part Number   | Case   | Packaging           |
|---------------|--------|---------------------|
| DMC2057UVT-7  | TSOT26 | 3000 / Tape & Reel  |
| DMC2057UVT-13 | TSOT26 | 10000 / Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See http://www.diodes.com/quality/lead\_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

## **Marking Information**



C57 = Product Type Marking Code YM = Date Code Marking Y or  $\overline{Y}$  = Year (ex: F = 2018) M or  $\overline{M}$  = Month (ex: 9 = September)

#### Date Code Key

| Year  | 2018 |     | 2019 | 2020 |     | 2021 | 2022 |     | 2023 | 2024 |     | 2025 |
|-------|------|-----|------|------|-----|------|------|-----|------|------|-----|------|
| Code  | F    |     | G    | Н    |     |      | J    |     | K    | L    |     | М    |
| Month | Jan  | Feb | Mar  | Apr  | May | Jun  | Jul  | Aug | Sep  | Oct  | Nov | Dec  |
| Code  | 1    | 2   | 3    | 4    | 5   | 6    | 7    | 8   | 9    | 0    | N   | D    |



#### **Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                                     | Symbol               | Q1 Value               | Q2 Value       | Unit       |              |   |
|--|----------------------|------------------------|----------------|------------|--------------|---|
| Drain-Source Voltage                               | Drain-Source Voltage |                        |                |            |              | V |
| Gate-Source Voltage                                | V <sub>GSS</sub>     | ±12                    | ±8             | V          |              |   |
| Continuous Drain Current (Note 6)                  | Oterate              | T .0500                |                | 4.0        | 0.0          |   |
| N-Channel: V <sub>GS</sub> = 4.5V                  | Steady<br>State      | $T_A = +25^{\circ}C$   | I <sub>D</sub> | 4.0<br>3.5 | -3.3<br>-2.6 | Α |
| P-Channel: V <sub>GS</sub> = -4.5V                 | State                | T <sub>A</sub> = +70°C |                | 3.5        | -2.0         |   |
| Maximum Continuous Body Diode Forward Current (    | I <sub>S</sub>       | 1.2                    | -1.3           | Α          |              |   |
| Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%) | I <sub>DM</sub>      | 25                     | -17            | Α          |              |   |

### **Thermal Characteristics**

| Characteristic                                   |                        | Symbol                           | Value       | Units |
|--|------------------------|----------------------------------|-------------|-------|
| Total Power Dissipation (Note 5)                 | T <sub>A</sub> = +25°C | $P_{D}$                          | 0.7         | W     |
| Thermal Resistance, Junction to Ambient (Note 5) | Steady State           | $R_{\theta JA}$                  | 173         | °C/W  |
| Total Power Dissipation (Note 6)                 | T <sub>A</sub> = +25°C | P <sub>D</sub>                   | 1.1         | W     |
| Thermal Resistance, Junction to Ambient (Note 6) | Steady State           | $R_{\theta JA}$                  | 108         | °C/W  |
| Thermal Resistance, Junction to Case             |                        | $R_{\theta JC}$                  | 37          | C/VV  |
| Operating and Storage Temperature Range          |                        | T <sub>J,</sub> T <sub>STG</sub> | -55 to +150 | °C    |

## Electrical Characteristics Q1 N-CHANNEL(@TA = +25°C, unless otherwise specified.)

| Characteristic                             | Symbol              | Min | Тур  | Max  | Unit | Test Condition                             |
|--|---------------------|-----|------|------|------|--|
| OFF CHARACTERISTICS (Note 7)               |                     |     |      |      |      |  |
| Drain-Source Breakdown Voltage             | BV <sub>DSS</sub>   | 20  | —    | _    | V    | $V_{GS} = 0V, I_D = 250\mu A$              |
| Zero Gate Voltage Drain Current            | I <sub>DSS</sub>    | l   | _    | 1.0  | μΑ   | $V_{DS} = 20V, V_{GS} = 0V$                |
| Gate-Source Leakage                        | I <sub>GSS</sub>    | 1   | _    | ±100 | nA   | $V_{GS} = \pm 12V, V_{DS} = 0V$            |
| ON CHARACTERISTICS (Note 7)                |                     |     |      |      |      |  |
| Gate Threshold Voltage                     | V <sub>GS(TH)</sub> | 0.4 | _    | 1.2  | V    | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$       |
|  |                     |     | 32   | 42   |      | $V_{GS} = 4.5V, I_D = 5.0A$                |
| Static Drain-Source On-Resistance          | R <sub>DS(ON)</sub> | _   | 40   | 60   | mΩ   | $V_{GS} = 2.5V, I_D = 4.0A$                |
|  | , ,                 |     | 50   | 91   |      | $V_{GS} = 1.8V, I_D = 2.0A$                |
| Diode Forward Voltage                      | $V_{SD}$            | _   | 0.7  | 1.2  | V    | $V_{GS} = 0V, I_{S} = 1A$                  |
| DYNAMIC CHARACTERISTICS (Note 8)           |                     |     |      |      |      |  |
| Input Capacitance                          | C <sub>iss</sub>    | _   | 416  | _    |      | 101/11/                                    |
| Output Capacitance                         | Coss                | _   | 44   | _    | pF   | $V_{DS} = 10V, V_{GS} = 0V$<br>f = 1.0MHz  |
| Reverse Transfer Capacitance               | C <sub>rss</sub>    | _   | 35   | _    |      | I = 1.0WHZ                                 |
| Gate Resistance                            | Rg                  | _   | 2.0  | _    | Ω    | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$ |
| Total Gate Charge (V <sub>GS</sub> = 4.5V) | $Q_g$               | _   | 4.7  | _    |      |  |
| Total Gate Charge (V <sub>GS</sub> = 10V)  | Qg                  | _   | 10.5 | _    | nC   | 101/1 00                                   |
| Gate-Source Charge                         | Qgs                 | _   | 0.4  | _    | IIC  | $V_{DS} = 10V$ , $I_D = 6A$                |
| Gate-Drain Charge                          | $Q_{gd}$            | _   | 1.2  | _    |      |  |
| Turn-On Delay Time                         | t <sub>D(ON)</sub>  | _   | 2.6  | _    |      |  |
| Turn-On Rise Time                          | t <sub>R</sub>      | _   | 3.3  | _    |      | $V_{DS} = 10V, V_{GS} = 4.5V,$             |
| Turn-Off Delay Time                        | t <sub>D(OFF)</sub> |     | 12.2 | _    | ns   | $R_q = 6\Omega$ , $I_D = 6A$               |
| Turn-Off Fall Time                         | t <sub>F</sub>      |     | 3.1  | _    |      |  |
| Reverse Recovery Time                      | t <sub>RR</sub>     | _   | 8.3  | _    | ns   | L CA 4:/4t 400A/                           |
| Reverse Recovery Charge                    | Q <sub>RR</sub>     | _   | 1.3  | _    | nC   | $I_F = 6A$ , di/dt = 100A/ $\mu$ s         |

5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout. Notes:

<sup>6.</sup> Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.
7. Short duration pulse test used to minimize self-heating effect.

<sup>8.</sup> Guaranteed by design. Not subject to production testing.



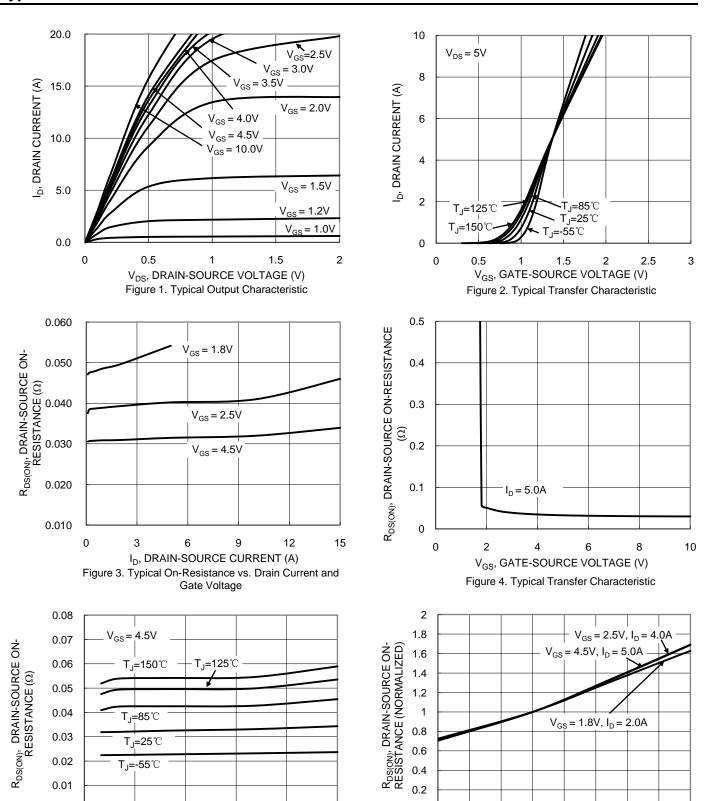
### Electrical Characteristics Q2 P-CHANNEL (@TA = +25°C, unless otherwise specified.)

| Characteristic                              | Symbol              | Min  | Тур  | Max  | Unit | Test Condition                              |  |  |
|---|---------------------|------|------|------|------|---|--|--|
| OFF CHARACTERISTICS (Note 7)                |                     |      |      |      |      |   |  |  |
| Drain-Source Breakdown Voltage              | $BV_{DSS}$          | -20  | _    | _    | V    | $V_{GS} = 0V, I_{D} = -250\mu A$            |  |  |
| Zero Gate Voltage Drain Current             | I <sub>DSS</sub>    | _    | 1    | -1.0 | μΑ   | $V_{DS} = -20V, V_{GS} = 0V$                |  |  |
| Gate-Source Leakage                         | I <sub>GSS</sub>    |      | _    | ±100 | nA   | $V_{GS} = \pm 8V, V_{DS} = 0V$              |  |  |
| ON CHARACTERISTICS (Note 7)                 |                     |      |      |      |      |   |  |  |
| Gate Threshold Voltage                      | V <sub>GS(TH)</sub> | -0.4 | -    | -1.0 | V    | $V_{DS} = V_{GS}, I_{D} = -250 \mu A$       |  |  |
|   |                     |      | 60   | 70   |      | $V_{GS} = -4.5V$ , $I_{D} = -3.5A$          |  |  |
| Static Drain-Source On-Resistance           | R <sub>DS(ON)</sub> | _    | 73.5 | 100  | mΩ   | $V_{GS} = -2.5V, I_D = -3.0A$               |  |  |
|   |                     |      | 113  | 160  |      | $V_{GS} = -1.8V, I_D = -2.0A$               |  |  |
| Diode Forward Voltage                       | $V_{SD}$            |      | -0.7 | -1.2 | V    | $V_{GS} = 0V, I_{S} = -1A$                  |  |  |
| DYNAMIC CHARACTERISTICS (Note 8)            |                     |      |      |      |      |   |  |  |
| Input Capacitance                           | C <sub>iss</sub>    | _    | 536  | _    |      | $V_{DS} = -10V, V_{GS} = 0V,$<br>f = 1.0MHz |  |  |
| Output Capacitance                          | Coss                | _    | 78   | _    | pF   |   |  |  |
| Reverse Transfer Capacitance                | Crss                |      | 69   | _    |      | I = I.OIVIHZ                                |  |  |
| Gate Resistance                             | $R_g$               |      | 32   | _    | Ω    | $V_{DS} = 0V$ , $V_{GS} = 0V$ , $f = 1MHz$  |  |  |
| Total Gate Charge (V <sub>GS</sub> = -4.5V) | $Q_g$               | _    | 6.5  | _    |      |   |  |  |
| Gate-Source Charge                          | Qgs                 | _    | 0.8  | _    | nC   | $V_{DS} = -4V, I_{D} = -3.5A$               |  |  |
| Gate-Drain Charge                           | $Q_{gd}$            | _    | 1.3  | _    |      |   |  |  |
| Turn-On Delay Time                          | t <sub>D(ON)</sub>  | _    | 4.4  | _    |      |   |  |  |
| Turn-On Rise Time                           | t <sub>R</sub>      | _    | 15.5 | _    |      | $V_{GS} = -4.5V, V_{DS} = -4V,$             |  |  |
| Turn-Off Delay Time                         | t <sub>D(OFF)</sub> | _    | 38.5 | _    | ns   | $R_g = 6\Omega$ , $R_L = 4\Omega$           |  |  |
| Turn-Off Fall Time                          | t <sub>F</sub>      | _    | 22.2 | _    |      | _   |  |  |
| Reverse Recovery Time                       | t <sub>RR</sub>     | _    | 11   | _    | ns   | $I_F = -2.0A$ , $di/dt = -100A/\mu s$       |  |  |
| Reverse Recovery Charge                     | Q <sub>RR</sub>     | _    | 2.6  | _    | nC   | $I_F = -2.0A$ , $di/dt = -100A/\mu s$       |  |  |

<sup>7.</sup> Short duration pulse test used to minimize self-heating effect. 8. Guaranteed by design. Not subject to production testing.



## **Typical Characteristics - N-CHANNEL**



I<sub>D</sub>, DRAIN CURRENT (A)
Figure 5. Typical On-Resistance vs. Drain Current and
Temperature

9

12

15

6

 $\label{eq:TJ} T_J, JUNCTION TEMPERATURE~(^{\circlearrowright})$  Figure 6. On-Resistance Variation with Temperature

50

75

100

0

0

3

0

-50

-25

0

25

125



#### Typical Characteristics - N-CHANNEL (Cont.)

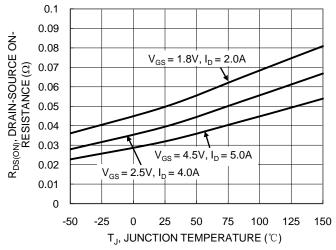
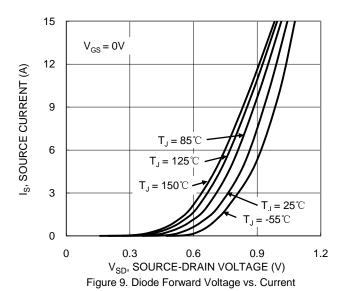
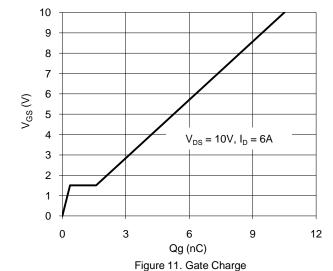


Figure 7. On-Resistance Variation with Temperature





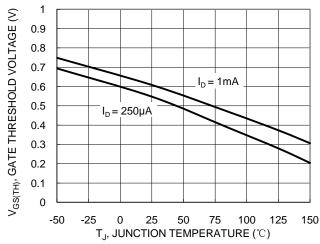


Figure 8. Gate Threshold Variation vs. Junction Temperature

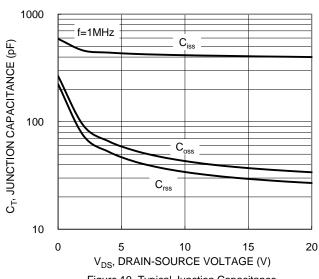
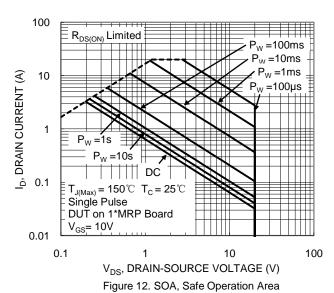
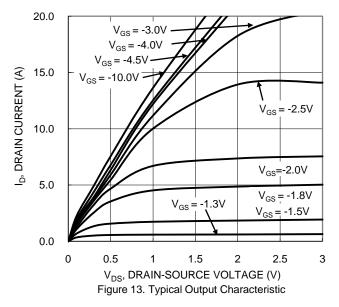


Figure 10. Typical Junction Capacitance





## **Typical Characteristics - P-CHANNEL**



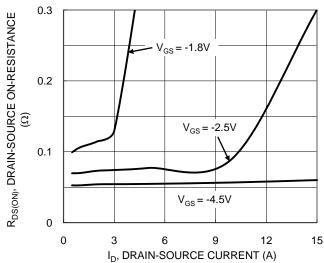


Figure 15. Typical On-Resistance vs. Drain Current and Gate Voltage

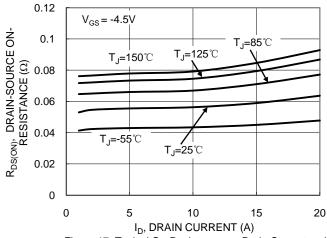
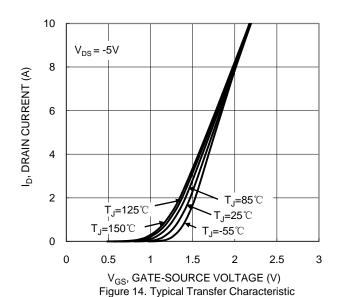
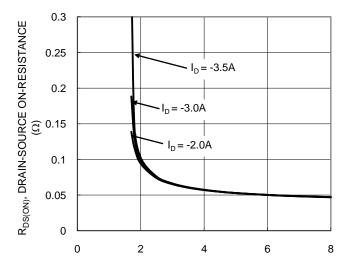


Figure 17. Typical On-Resistance vs. Drain Current and Junction Temperature





V<sub>GS</sub>, GATE-SOURCE VOLTAGE (V)
Figure 16. Typical Transfer Characteristic

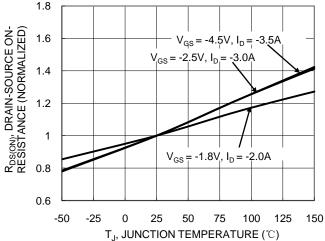
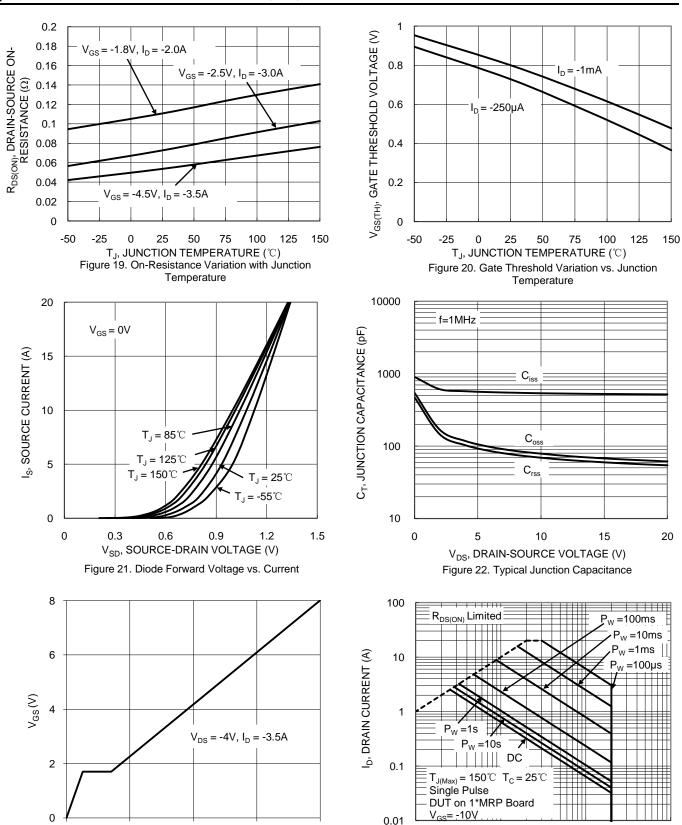


Figure 18. On-Resistance Variation with Junction Temperature



#### Typical Characteristics - P-CHANNEL (Cont.)



0

3

6

Qg (nC)

Figure 23. Gate Charge

9

0.1

12

 $V_{DS}$ , DRAIN-SOURCE VOLTAGE (V)

Figure 24. SOA, Safe Operation Area

100



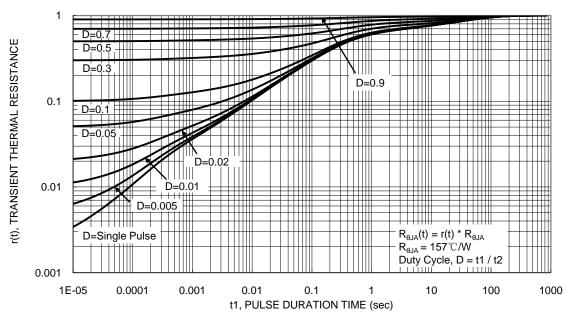
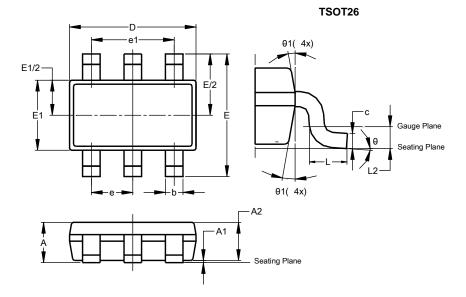


Figure 25. Transient Thermal Resistance



## **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

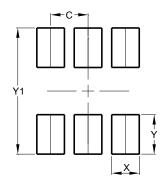


|            | TSOT26      |           |       |  |  |  |  |  |  |
|------------|-------------|-----------|-------|--|--|--|--|--|--|
| Dim        | Min Max Typ |           |       |  |  |  |  |  |  |
| Α          | -           | 1.00      | 1     |  |  |  |  |  |  |
| <b>A</b> 1 | 0.010       | 0.100     | -     |  |  |  |  |  |  |
| A2         | 0.840       | 0.900     | 1     |  |  |  |  |  |  |
| D          | 2.800       | 3.000     | 2.900 |  |  |  |  |  |  |
| Е          | 2           | 2.800 BSC |       |  |  |  |  |  |  |
| E1         | 1.500       | 1.700     | 1.600 |  |  |  |  |  |  |
| b          | 0.300       | 0.450     | -     |  |  |  |  |  |  |
| С          | 0.120       | 0.200     | 1     |  |  |  |  |  |  |
| e          | 0.950 BSC   |           |       |  |  |  |  |  |  |
| e1         | 1           | .900 BS   | С     |  |  |  |  |  |  |
| L          | 0.30        | 0.50      | -     |  |  |  |  |  |  |
| L2         | 0.250 BSC   |           |       |  |  |  |  |  |  |
| θ          | 0°          | 8°        | 4°    |  |  |  |  |  |  |
| θ1         | 4°          | 12°       | -     |  |  |  |  |  |  |
| A          | II Dimen    | sions in  | mm    |  |  |  |  |  |  |

## **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

#### TSOT26



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 0.950         |
| Х          | 0.700         |
| Y          | 1.000         |
| Y1         | 3.199         |



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